

N-Channel Enhancement-Mode Power MOS Field-Effect Transistors

August 1991

Features

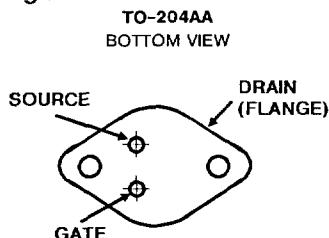
- 12A and 14A, 350V - 400V
 - $r_{DS(on)} = 0.4\Omega$ and 0.3Ω
 - SOA is Power-Dissipation Limited
 - Nanosecond Switching Speeds
 - Linear Transfer Characteristics
 - High Input Impedance
 - Majority Carrier Device

Description

The 2N6767 and 2N6768 are n-channel enhancement-mode silicon-gate power MOS field-effect transistors designed for applications such as switching regulators, switching converters, motor drivers, relay drivers, and drivers for high-power bipolar switching transistors requiring high speed and low gate-drive power. These types can be operated directly from integrated circuits.

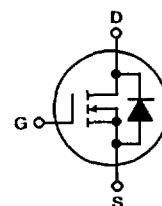
These types are supplied in the JEDEC TO-204AA steel package.

|| Package



Terminal Diagram

N-CHANNEL ENHANCEMENT MODE



4

N-CHANNEL POWER MOSFETs

Absolute Maximum Ratings ($T_C = +25^\circ\text{C}$) Unless Otherwise Specified

* JEDEC registered values

CAUTION: These devices are sensitive to electrostatic discharge. Proper I.C. handling procedures should be followed.
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Electrical Characteristics @ $T_C = 25^\circ\text{C}$ (Unless Otherwise Specified)

Parameter	Type	Min.	Typ.	Max.	Units	Test Conditions
V_{DSS} Drain - Source Breakdown Voltage	2N6767	350	—	—	V	$V_{GS} = 0$
	2N6768	400	—	—	V	$I_D = 1.0 \text{ mA}$
$V_{GS(\text{th})}$ Gate Threshold Voltage	ALL	2.0*	—	4.0*	V	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$
I_{GSSF} Gate - Body Leakage Forward	ALL	—	—	100*	nA	$V_{GS} = 20V$
I_{GSSA} Gate - Body Leakage Reverse	ALL	—	—	100*	nA	$V_{GS} = -20V$
I_{DSS} Zero Gate Voltage Drain Current	ALL	—	0.1	1.0*	mA	$V_{DS} = \text{Max. Rating}, V_{GS} = 0$
		—	0.2	4.0*	mA	$V_{DS} = \text{Max. Rating}, V_{GS} = 0, T_C = 125^\circ\text{C}$
$V_{DS(on)}$ Static Drain-Source On-State Voltage	2N6767	—	—	5.4*	V	$V_{GS} = 10V, I_D = 12A$
	2N6768	—	—	5.6*	V	$V_{GS} = 10V, I_D = 14A$
$R_{DS(on)}$ Static Drain-Source On-State Resistance	2N6767	—	0.3	0.4*	Ω	$V_{GS} = 10V, I_D = 7.75A$
	2N6768	—	0.25	0.3*	Ω	$V_{GS} = 10V, I_D = 9.0A$
$R_{DS(on)}$ Static Drain-Source On-State Resistance	2N6767	—	—	0.88*	Ω	$V_{GS} = 10V, I_D = 7.75A, T_C = 125^\circ\text{C}$
	2N6768	—	—	0.66*	Ω	$V_{GS} = 10V, I_D = 9.0A, T_C = 125^\circ\text{C}$
B_{fs} Forward Transconductance	ALL	8.0*	11.0	24*	S (U)	$V_{DS} = 15V, I_D = 9.0A$
C_{iss} Input Capacitance	ALL	1000*	2000	3000*	pF	$V_{GS} = 0, V_{DS} = 25V, f = 1.0 \text{ MHz}$
C_{oss} Output Capacitance	ALL	200*	400	600*	pF	See Fig. 10
C_{trs} Reverse Transfer Capacitance	ALL	50*	100	200*	pF	
$t_{d(on)}$ Turn-On Delay Time	ALL	—	—	35*	ns	$V_{DD} \geq 180V, I_D = 9.0A, Z_o = 4.7\Omega$
t_r Rise Time	ALL	—	—	65*	ns	(See Figs. 13 and 14)
$t_{d(off)}$ Turn-Off Delay Time	ALL	—	—	150*	ns	(MOSFET switching times are essentially
t_f Fall Time	ALL	—	—	75*	ns	independent of operating temperature.)

Thermal Resistance

R_{thJC} Junction-to-Case	ALL	—	—	0.83*	$^\circ\text{C}/\text{W}$	
R_{thCS} Case-to-Sink	ALL	—	0.1	—	$^\circ\text{C}/\text{W}$	Mounting surface flat, smooth, and greased.
R_{thJA} Junction-to-Ambient	ALL	—	—	30	$^\circ\text{C}/\text{W}$	Free Air Operation

Body-Drain Diode Ratings and Characteristics

I_S Continuous Source Current (Body Diode)	2N6767	—	—	12*	A	Modified MOSFET symbol showing the integral reverse P-N junction rectifier.
	2N6768	—	—	14*		
I_{SM} Pulsed Source Current (Body Diode)	2N6767	—	—	20	A	
	2N6768	—	—	25		
V_{SD} Diode Forward Voltage	2N6767	0.8*	—	1.6*	V	$T_C = 25^\circ\text{C}, I_S = 12A, V_{GS} = 0$
	2N6768	0.85*	—	1.7*	V	
t_{rr} Reverse Recovery Time	ALL	—	1000	—	ns	$T_J = 150^\circ\text{C}, I_F = I_{SM}, dI_F/dt = 100 \text{ A}/\mu\text{s}$
Q_{RR} Reverse Recovered Charge	ALL	—	25	—	μC	$T_J = 150^\circ\text{C}, I_F = I_{SM}, dI_F/dt = 100 \text{ A}/\mu\text{s}$

* JEDEC registered values. ① Pulse Test: Pulse Width $\leq 300 \mu\text{sec}$, Duty Cycle $\leq 2\%$

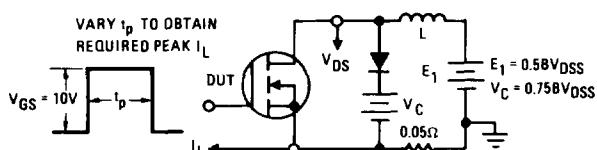


Fig. 1 - Clamped inductive test circuit.

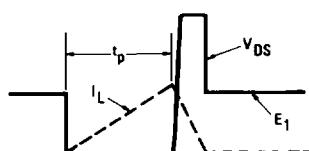


Fig. 2 - Clamped inductive waveforms.

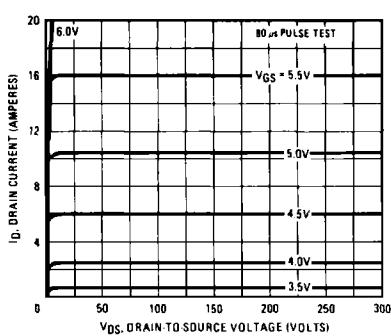
2N6767, 2N6768

Fig. 3 - Typical output characteristics for both types.

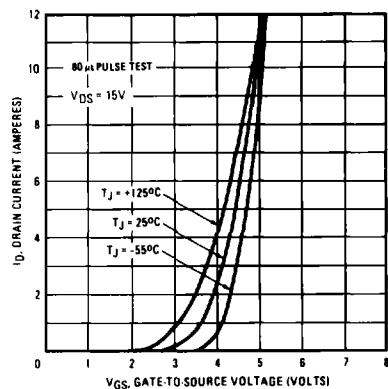


Fig. 4 - Typical transfer characteristics for both types.

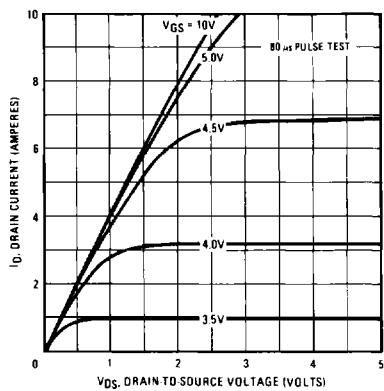


Fig. 5 - Typical saturation characteristics for the 2N6767.

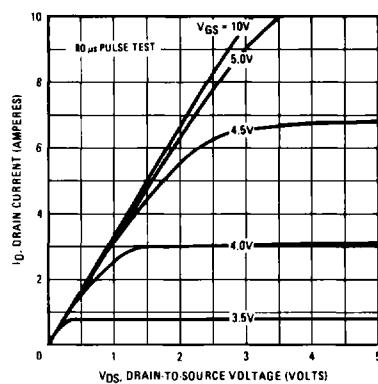


Fig. 6 - Typical saturation characteristics for the 2N6768.

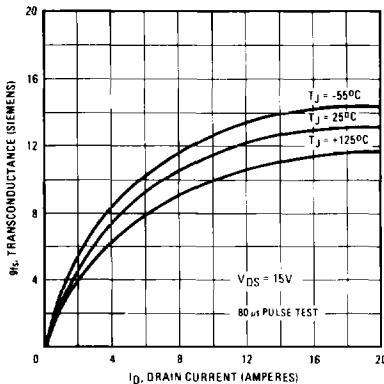


Fig. 7 - Typical transconductance versus drain current for both types.

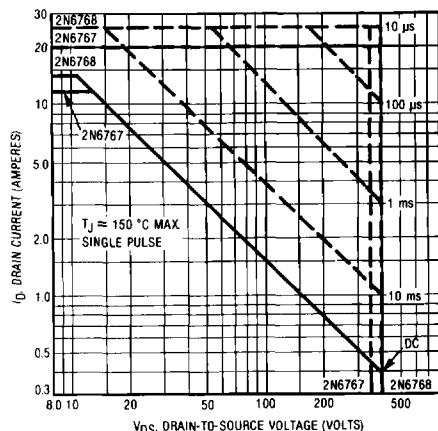


Fig. 8 - Maximum safe operating area for both types.

2N6767, 2N6768

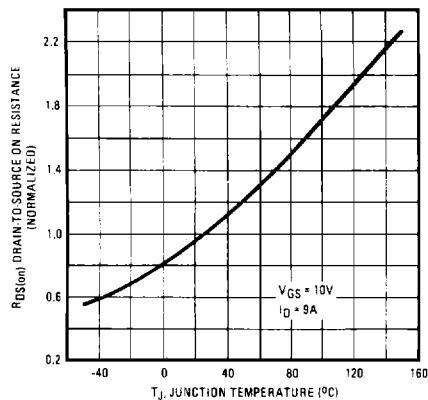


Fig. 9 - Typical normalized on-resistance versus temperature for both types.

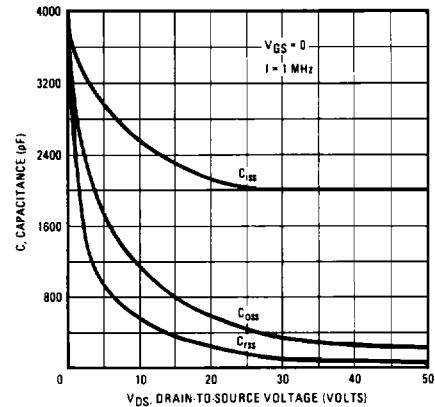


Fig. 10 - Typical capacitance versus drain-to-source voltage for both types.

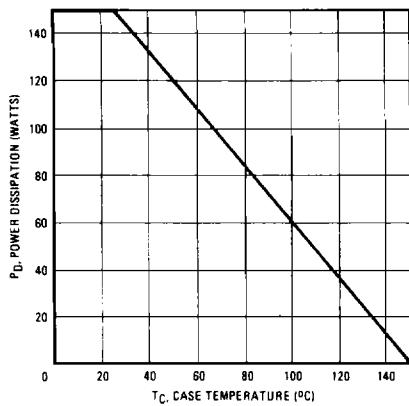


Fig. 11 - Power versus temperature derating curve for both types.

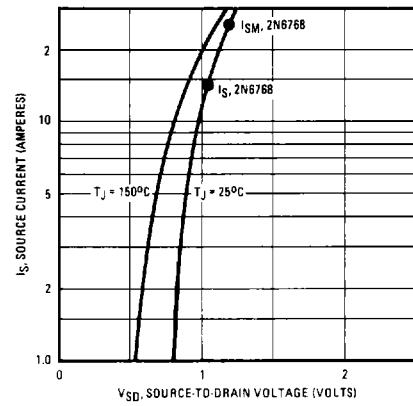


Fig. 12 - Typical body-drain diode forward voltage for both types.

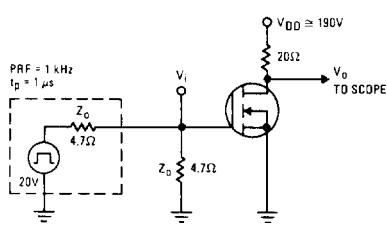


Fig. 13 - Switching time test circuit.

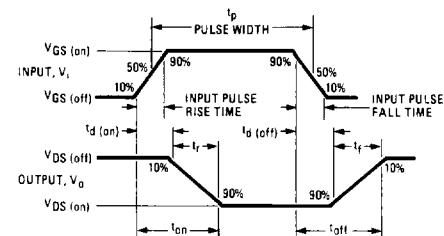


Fig. 14 - Switching time waveforms